CMPT930

SURFACE MOUNT NPN SILICON TRANSISTOR



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DESCRIPTION:

The CENTRAL SEMICONDUCTOR CMPT930 type is an NPN silicon transistor manufactured by the epitaxial planar process, epoxy molded in a surface mount package, designed for small signal general purpose and switching applications.

MARKING CODE: C1X



MAXIMUM RATINGS: (T _A =25°C)	SYMBOL		UNITS
Collector-Base Voltage	V_{CBO}	45	V
Collector-Emitter Voltage	V_{CEO}	45	V
Emitter-Base Voltage	V_{EBO}	5.0	V
Continuous Collector Current	$I_{\mathbb{C}}$	30	mA
Power Dissipation	P_{D}	350	mW
Operating and Storage Junction Temperature	T _J , T _{stg}	-65 to +150	°C
Thermal Resistance	$\Theta_{\sf JA}$	357	°C/W

ELECTRICAL CHARACTERISTICS: (T_A=25°C unless otherwise noted)

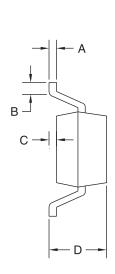
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SYMBOL	TEST CONDITIONS	MIN	MAX	UNITS			
I _{CBO}	V _{CB} =45V		10	nA			
ICEO	V _{CE} =5.0V		10	nA			
ICES	V _{CE} =45V		10	nA			
I _{EBO}	V _{EB} =5.0V		10	nA			
BVCBO	I _C =10μA	45		V			
BVCEO	I _C =10mA	45		V			
BVEBO	I _E =10μA	5.0		V			
VCE(SAT)	I _C =10mA, I _B =0.5mA		1.0	V			
V _{BE} (SAT)	I _C =10mA, I _B =0.5mA	0.6	1.0	V			
hFE	V_{CE} =5.0V, I_{C} =10 μ A	100	300				
hFE	V_{CE} =5.0V, I_{C} =500 μ A	150					
hFE	V_{CE} =5.0V, I_{C} =10mA		600				
f _T	V_{CE} =5.0V, I_{C} =500mA, f=30MHz	30		MHz			
C_{ob}	V_{CB} =5.0V, I_E =0, f=1.0MHz		8.0	pF			
NF	V_{CE} =5.0V, I_{C} =10mA, R_{S} =10k Ω ,						
	f=10Hz to 15.7kHz		3.0	dB			

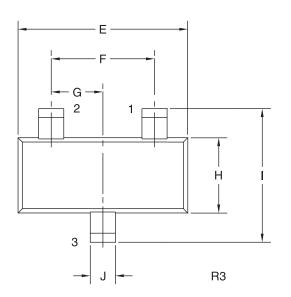
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SOT-23 CASE - MECHANICAL OUTLINE





LEAD CODE:

- 1) Base 2) Emitter 3) Collector

MARKING CODE: C1X

DIMENSIONS							
	INCHES		MILLIMETERS				
SYMBOL	MIN	MAX	MIN	MAX			
Α	0.003	0.007	0.08	0.18			
В	0.006	-	0.15	-			
С	-	0.005	-	0.13			
D	0.035	0.043	0.89	1.09			
Е	0.110	0.120	2.80	3.05			
F	0.075		1.90				
G	0.037		0.95				
Н	0.047	0.055	1.19	1.40			
ĺ	0.083	0.098	2.10	2.49			
J	0.014	0.020	0.35	0.50			

SOT-23 (REV: R3)

OUTSTANDING SUPPORT AND SUPERIOR SERVICES



PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- · Inventory bonding
- · Consolidated shipping options

- · Custom bar coding for shipments
- · Custom product packing

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free guick ship samples (2nd day air)
- Online technical data and parametric search
- SPICE models
- · Custom electrical curves
- · Environmental regulation compliance
- · Customer specific screening
- · Up-screening capabilities

- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- · Application and design sample kits
- · Custom product and package development

REQUESTING PRODUCT PLATING

- 1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
- 2. If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

CONTACT US

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